Preface

Dear Distinguished Authors and Guests,

The Organizing Committee warmly welcomes you to the 2014 2nd International Conference on Mechanical Structures and Smart Materials (2nd ICMSSM 2014), held in Kuala Lumpur, Malaysia, August 16-17, 2014.

The topics of ICMSSM 2014 cover different areas of Mechanical Structures and Mechanical Engineering, Material Science and Engineering, Materials Manufacturing and Processing .The peer-reviewed, selected papers and additional lectures with breakthrough contributions enlighten the technical program. Apparently, the conference program is extremely rich, professional, and featured with high-impact. The aims of the conference therefore provide an excellent platform for participants to exchange and share new ideas and practical experiences, to establish business or research relations and to search global partners for future collaboration.

We earnestly hope that the conference proceeding can contribute and provide you for significant and improved knowledge in the contemporary scientific and material fields.

On behalf of the organizing committee, I would like to thank Anne, Tanja, Dorthe and all the editors from Trans Tech Publications for their great support to ICMSSM 2014. Without their excellent editorial work, the proceedings of ICMSSM 2014 cannot be published so timely and successfully.

Finally we wish all the authors and attendees a unique, rewarding and enjoyable memory at the 2nd ICMSSM2014 in Kuala Lumpur, Malaysia. We look forward to your participation in the 3rd ICMSSM in 2015.

With our warmest regards,

Jenny Ji

Conference Organizing Chair

August 26, 2014

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